

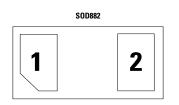
SP1250 50A Discrete Unidirectional TVS Diode

F Rohs 🕫 Green

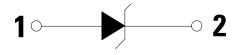


Note: This package image is for example and reference only. for detail package drawing, please refer to the package section in this datasheet.

Pinout



Functional Block Diagram



Description

The SP1250 unidirectional TVS is fabricated in a proprietary silicon avalanche technology. These diodes provide a high ESD (electrostatic discharge) protection level for electronic equipment. The SP1250 TVS can safely absorb repetitive ESD strikes of \pm 30 kV (contact and air discharge as defined in IEC 61000-4-2) without any performance degradation. Additionally, each TVS can safely dissipate a 50A 8/20µs surge event as defined in IEC 61000-4-5 2nd edition.

Features

- ESD, IEC 61000-4-2, ±30kV contact, ±30kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, 50A (8/20µs as defined in IEC 61000-4-5 2nd edition)
- Low leakage current of 0.02µA (TYP) at 5V
- Halogen free, lead free and RoHS compliant
- Moisture Sensitivity Level (MSL -1)

Applications

- VBUS Protection
- Portable Battery
- Switches / Buttons
- Test Equipment / Instrumentation
- Medical Equipment
- Notebooks / Desktops / Servers
- Computer Peripherals
- Point-of-Sale Terminals

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
I _{pp}	Peak Current (t _p =8/20µs)	50	А
T _{op}	Operating Temperature	-40 to 125	°C
T _{STOR}	Storage Temperature	-55 to 150	°C

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

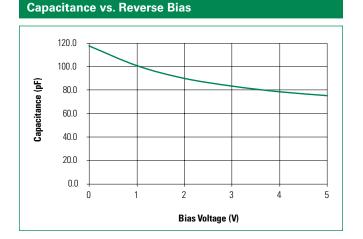
Electrical Characteristics (T_{OP}=25°C)

OP						
Parameter	Symbol Test Conditions		Min	Тур	Мах	Units
Reverse Standoff Voltage	V _{RWM}	I _R =1µA	-	-	5	V
Breakdown Voltage	V _{BR}	I _R =1mA	5.1	5.5	-	V
Reverse Leakage Current	I _{LEAK}	V _R =5V	-	0.02	0.1	μA
Clamp Voltage ¹	V _c	I _{pp} =50Α, t _p =8/20μs	-	8.7	10	V
Dynamic Resistance ²	R _{DYN}	TLP, t _p =100ns	-	0.05	-	Ω
ESD Withstand Voltage ¹	V _{ESD} -	IEC 61000-4-2 (Contact Discharge)	±30	-	-	kV
		IEC 61000-4-2 (Air Discharge)	±30	-	-	kV
Diode Capacitance ¹	C _{IO-GND}	Reverse Bias=0V, f=1MHz	-	120	-	pF

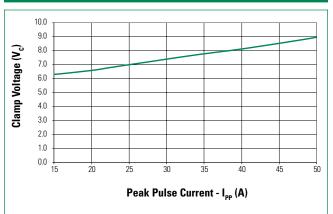
Note:

1. Parameter is guaranteed by design and/or component characterization.

2. Transmission Line Pulse (TLP) with 100ns width, 0.2ns rise time, and average window t1=70ns to t2= 90ns

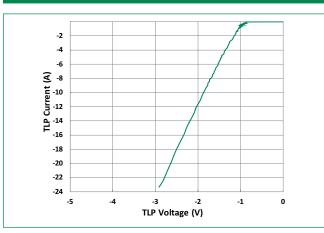


Clamping voltage vs. I_{pp} for 8/20µs waveshape

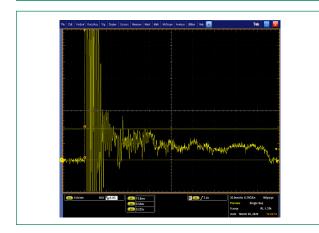


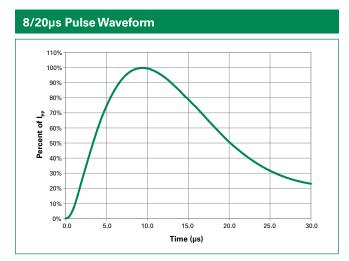


Negative Transmission Line Pulsing (TLP) Plot

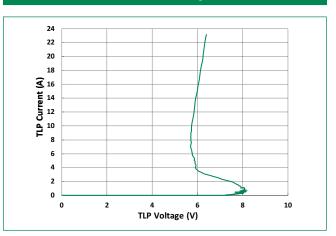


IEC 61000-4-2 +8 kV Contact ESD Clamping Voltage

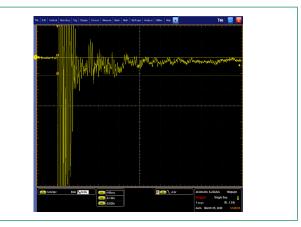




Positive Transmission Line Pulsing (TLP) Plot



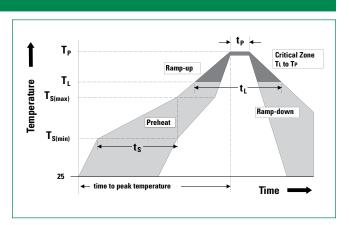
IEC 61000-4-2 -8 kV Contact ESD Clamping Voltage



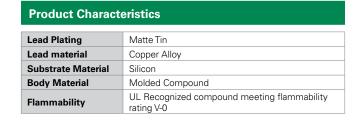


Soldering Parameters

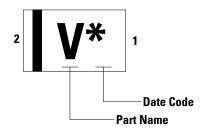
Reflow Cond	Pb – Free assembly		
Pre Heat	- Temperature Min (T _{s(min)})	150°C	
	- Temperature Max (T _{s(max)})	200°C	
	- Time (min to max) (t _s)	60 – 180 secs	
Average ram	3°C/second max		
$T_{S(max)}$ to T_{L} -	3°C/second max		
Reflow	- Temperature (T _L) (Liquidus)	217°C	
	- Temperature (t _L)	60 – 150 seconds	
Peak Temperature (T _p)		260 ^{+0/-5} °C	
Time within 5°C of actual peak Temperature (t _p)		20 – 40 seconds	
Ramp-down Rate		6°C/second max	
Time 25°C to peak Temperature (T _P)		8 minutes Max.	
Do not exceed		260°C	



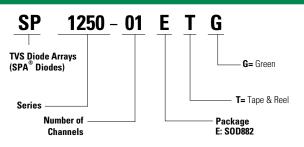
Ordering Information					
Part Number	Package	Min. Order Qty.			
SP1250-01ETG	SOD882	10,000			



Part Marking System

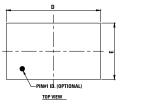


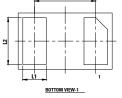
Part Numbering System





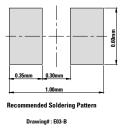
Package Dimensions – SOD882



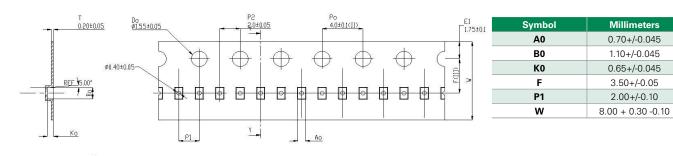


	SOD882					
Symbol	Millimeters		Inches			
	Min	Тур	Max	Min	Тур	Max
Α	0.40	0.50	0.55	0.016	0.020	0.022
A1	0.00	0.02	0.05	0.000	0.001	0.002
L1	0.20	0.25	0.30	0.008	0.010	0.012
L2	0.45	0.50	0.55	0.018	0.020	0.022
D	0.95	1.00	1.05	0.037	0.039	0.041
E	0.55	0.60	0.65	0.022	0.024	0.026
е		0.65 BSC			0.026 BSC	

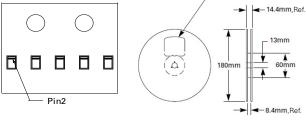




Embossed Carrier Tape & Reel Specification - SOD882



Component Orientation in Tape



8mm TAPE AND REEL

ACCESS HOLE, Ref.

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